

FAIRCHILD

A Schlumberger Company

2N6755/2N6756 T-39-11
N-Channel Power MOSFETs,
14 A, 60 V/100 V

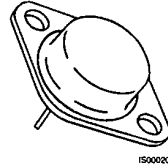
Power And Discrete Division

Description

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high power, high speed applications, such as switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers and high energy pulse circuits.

- V_{GS} Rated at ± 20 V
- Silicon Gate for Fast Switching Speeds
- I_{DSS} , $R_{DS(on)}$, Specified at Elevated Temperature
- Rugged
- Low Drive Requirements
- Ease of Paralleling

TO-204AA

2N6755
2N6756**Maximum Ratings**

Symbol	Characteristic	Rating 2N6756	Rating 2N6755	Unit
V_{DSS}	Drain to Source Voltage	100	60	V
V_{DGR}	Drain to Gate Voltage $R_{GS} = 1 \text{ M}\Omega$	100	60	V
V_{GS}	Gate to Source Voltage	± 20	± 20	V
T_J, T_{stg}	Operating Junction and Storage Temperatures	-55 to +150	-55 to +150	$^{\circ}\text{C}$
T_L	Maximum Lead Temperature for Soldering Purposes, 1/16" From Case for 10 s	300	300	$^{\circ}\text{C}$

Maximum On-State Characteristics

$R_{DS(on)}$	Static Drain-to-Source On Resistance	0.18	0.25	Ω
I_D	Drain Current Continuous at $T_C = 25^{\circ}\text{C}$ Continuous at $T_C = 100^{\circ}\text{C}$	14 9	12 8	A
I_{DM}	Pulsed	30^2	25^2	

Maximum Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.67	1.67	$^{\circ}\text{C}/\text{W}$
P_D	Total Power Dissipation at $T_C = 25^{\circ}\text{C}$	75	75	W
	Linear Derating Factor	0.6	0.6	$\text{W}/^{\circ}\text{C}$

Notes

All values are JEDEC registered except as noted. For information concerning connection diagram and package outline, refer to Section 7.

84 DE 3469674 0027791 1

2N6755/2N6756

T-39-11

Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
Off Characteristics					
$V_{(BR)DSS}$	Drain Source Breakdown Voltage 2N6756 2N6755			V	$V_{GS} = 0\text{ V}, I_D = 1\text{ mA}$
		100 ²			
		60 ²			
I_{DSS}	Zero Gate Voltage Drain Current		1	mA	$V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}$ $V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0\text{ V}, T_C = 125^\circ\text{C}$
			4		
I_{GSS}	Gate-Body Leakage Current		± 100	nA	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$
On Characteristics					
$V_{GS(th)}$	Gate Threshold Voltage	2.0	4.0	V	$I_D = 1\text{ mA}, V_{DS} = V_{GS}$
$R_{DS(on)}$	Static Drain-Source On-Resistance ¹ 2N6756 2N6755		0.18	Ω	$V_{GS} = 10\text{ V}$ $I_D = 9\text{ A}$ $I_D = 8\text{ A}$
			0.25		
	2N6756 2N6755		0.33	Ω	$V_{GS} = 10\text{ V}, T_C = 125^\circ\text{C}$ $I_D = 9\text{ mA}$ $I_D = 8\text{ A}$
			0.45		
$V_{DS(on)}$	Drain-Source On-Voltage ¹ 2N6756 2N6755		2.52	V	$V_{GS} = 10\text{ V}; I_D = 14\text{ A}$ $V_{GS} = 10\text{ V}; I_D = 12\text{ A}$
			3.0		
g_{fs}	Forward Transconductance ¹	4.0	12	S (Ω)	$V_{DS} = 10\text{ V}, I_D = 9\text{ A}$
Dynamic Characteristics					
C_{iss}	Input Capacitance	350	800	pF	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$
C_{oss}	Output Capacitance	150	500	pF	
C_{rss}	Reverse Transfer Capacitance	50	150	pF	
Switching Characteristics ($T_C = 25^\circ\text{C}$, Figures 9, 10)					
$t_{d(on)}$	Turn-On Delay Time		30	ns	$V_{DD} = 36\text{ V}, I_D = 9\text{ A}$ $V_{GS} = 10\text{ V}, R_{GEN} = 15\ \Omega$ $R_{GS} = 15\ \Omega$
t_r	Rise Time		75	ns	
$t_{d(off)}$	Turn-Off Delay Time		40	ns	
t_f	Fall Time		45	ns	
Q_g	Total Gate Charge		30 ²	nC	$V_{GS} = 10\text{ V}, I_D = 18\text{ A}$ $V_{DD} = 55\text{ V}$

Electrical Characteristics (Cont.) ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Characteristic	Min	Typ	Max	Unit	Test Conditions
Source-Drain Diode Characteristics						
I_S	Continuous Source Current 2N6756 2N6755			14 12	A	
I_{SM}	Pulsed Source Current 2N6756 2N6755			30^2 25^2	A	
V_{SD}	Diode Forward Voltage 2N6756 2N6755	0.90		1.8	V	$I_S = 14\text{ A}; V_{GS} = 0\text{ V}$
		0.85		1.7	V	$I_S = 12\text{ A}; V_{GS} = 0\text{ V}$
t_{rr}	Reverse Recovery Time		300^2		ns	$V_{GS} = 0\text{ V}, T_J = 150^\circ\text{C}$ $I_F = I_{SM}, dI_F/dt = 100\text{ A}/\mu\text{S}$
Q_{RR}	Reverse Recovery Charge		4.0^2		μC	$V_{GS} = 0\text{ V}, T_J = 150^\circ\text{C}$ $I_F = I_{SM}, dI_F/dt = 100\text{ A}$

Notes

1. Pulse test: Pulse width $\leq 300\ \mu\text{s}$, Duty cycle $\leq 1\%$
2. Non-JEDEC registered value.

Typical Performance Curves

Figure 1 Output Characteristics

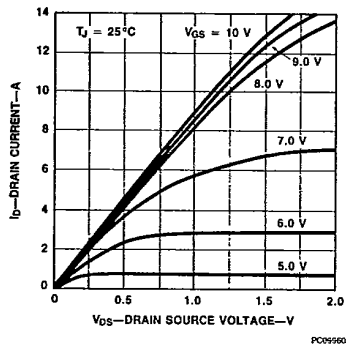
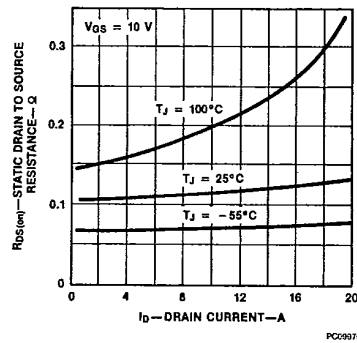


Figure 2 Static Drain to Source Resistance vs Drain Current



Typical Performance Curves (Cont.)

Figure 3 Transfer Characteristics

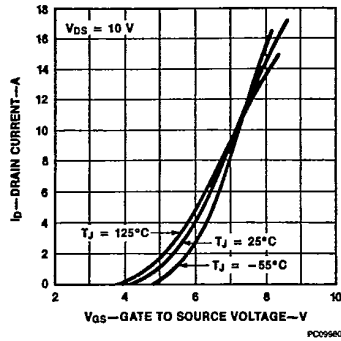


Figure 4 Temperature Variation of Gate to Source Threshold Voltage

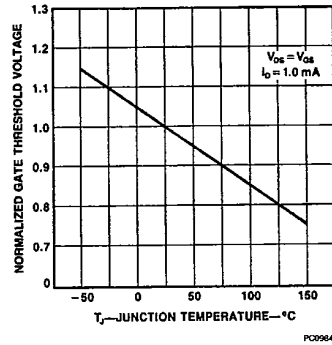


Figure 5 Capacitance vs Drain to Source Voltage

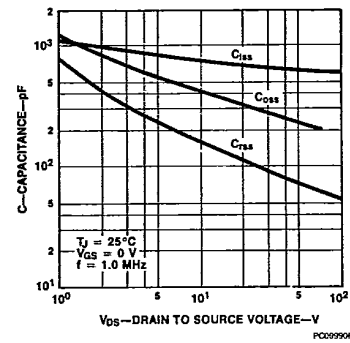


Figure 6 Gate to Source Voltage vs Total Gate Charge

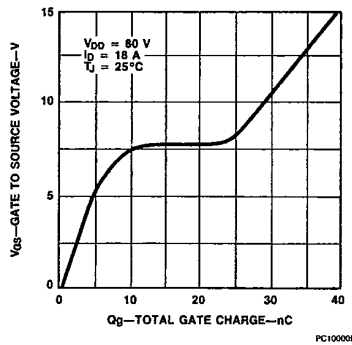


Figure 7 Forward Biased Safe Operating Area

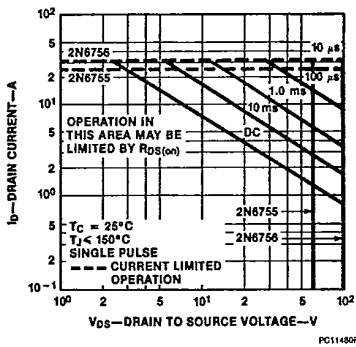
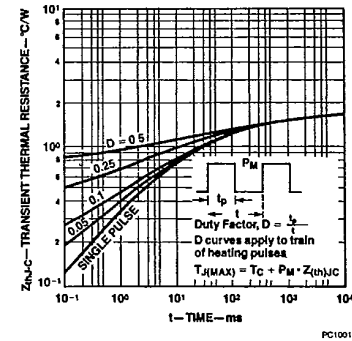
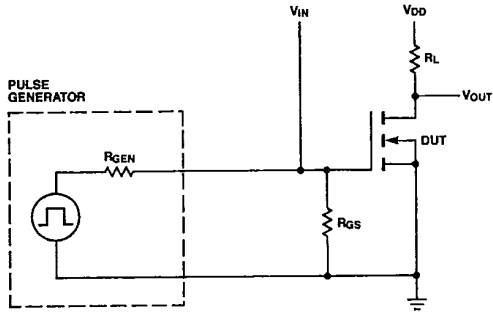


Figure 8 Transient Thermal Resistance vs Time



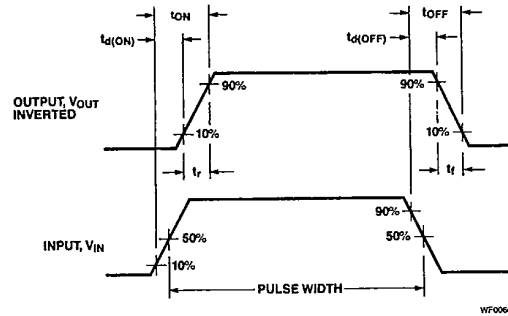
Typical Electrical Characteristics

Figure 9 Switching Test Circuit



CR04450F

Figure 10 Switching Waveforms



WF00600F

This datasheet has been downloaded from:

www.DatasheetCatalog.com

Datasheets for electronic components.



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

LittleDiode.com

Looking forward to providing you with the best possible service.